



Product Change Notification

Change Notification #: 116062 - 00

Change Title: Select Intel® SSD Pro 7600p,
Intel® SSD 760p and
Intel® SSD E 6100p Series Products,
PCN 116062-00, Label,
Label Update

Date of Publication: February 08, 2018

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	February 23, 2018
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Description of Change to the Customer:

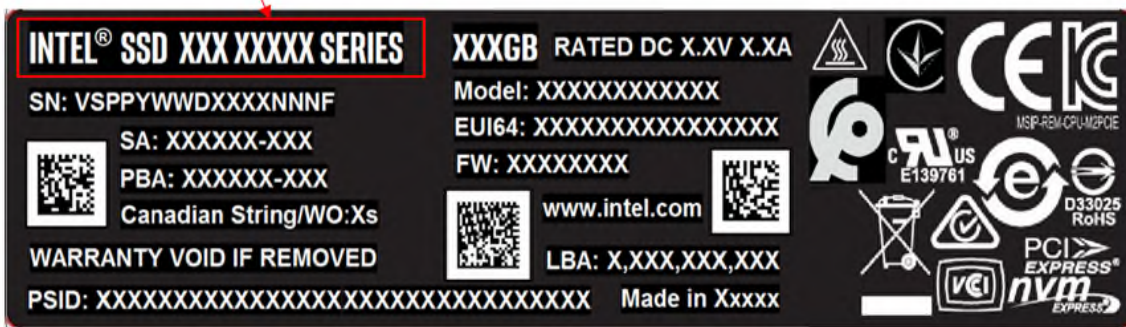
The Intel® SSD Pro 7600p, Intel® SSD 760p and Intel® SSD E 6100p Series SKUs listed in the products affected table will have the following change:

- The Product Name on the label is being updated from uppercase "P" to lowercase "p" as shown in the label picture below.

Product Name use lowercase "p"

As is 7600P, 760P, E6100P

To be: 7600p, 760p, E6100p



Customer Impact of Change and Recommended Action:

There is no change to the form, fit, or function of the product. The change is only to the labels used in packaging. Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD 760p Series (1.024TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKW010T8X1	962568
Intel® SSD 760p Series (2.048TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKW020T8X1	962569
Intel® SSD 760p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box 10 Pack	SSDPEKKW128G8XT	963289
Intel® SSD 760p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box 10 Pack	SSDPEKKW256G8XT	963290
Intel® SSD 760p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box 10 Pack	SSDPEKKW512G8XT	963291
Intel® SSD Pro 7600p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF128G8X1	963303
Intel® SSD Pro 7600p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF256G8X1	963304
Intel® SSD Pro 7600p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF512G8X1	963305
Intel® SSD Pro 7600p Series (1.024TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF010T8X1	963306
Intel® SSD Pro 7600p Series (2.048TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF020T8X1	963307
Intel® SSD E 6100p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKR128G801	963756
Intel® SSD E 6100p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKR256G801	963758
Intel® SSD E 6100p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic 10 Pack	SSDPEKKR128G810	963759
Intel® SSD E 6100p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic 10 Pack	SSDPEKKR256G810	963760
Intel® SSD E 6100p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic 50 Pack	SSDPEKKR128G8	963761
Intel® SSD E 6100p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic 50 Pack	SSDPEKKR256G8	963762
Intel® SSD 760p Series (128GB, M.2 80mm, PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKW128G801	963928
Intel® SSD 760p Series (256GB, M.2 80mm, PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKW256G801	963929
Intel® SSD 760p Series (512GB, M.2 80mm, PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKW512G801	963930

PCN Revision History:

Date of Revision:
February 8, 2018

Revision Number:
00

Reason:
Originally Published PCN



Product Change Notification

116062 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

Europe Email: eccb@intel.com

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